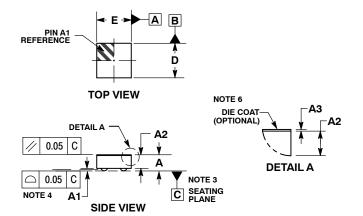
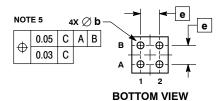


WLCSP4, 0.77x0.77 CASE 567JY **ISSUE C**

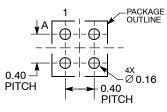
DATE 07 MAR 2017







RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
- CONTROLLING DIMENSION: MILLIMETERS.
 DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- COPLANARITY APPLIES TO SPHERICAL CROWNS OF THE SOLDER BALLS.
- 5. DIMENSION b IS MEASURED AT THE MAXIMUM CONTACT BALL DIAMETER PARALLEL TO DATUM C.
 6. BACKSIDE COATING IS OPTIONAL.

	MILLIMETERS		
DIM	MIN	NOM	MAX
Α			0.35
A1	0.04	0.06	0.08
A2	0.23 REF		
A3	0.025 REF		
b	0.15	0.155	0.16
D	0.75	0.77	0.79
E	0.75	0.77	0.79
е	0.40 BSC		

GENERIC MARKING DIAGRAM*



= Specific Device Code

= Year

W = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator. "G" or microdot " ■". may or may not be present.

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^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.